

## Low loss Duopack: IGBT 7 with Trench and Fieldstop technology

### Features

- $V_{CE} = 650\text{ V}$
- $I_C = 75\text{ A}$
- Very low  $V_{CE,sat}$
- Low turn-off losses
- Short tail current
- Reduced EMI
- Very soft, fast recovery antiparallel diode
- Maximum junction temperature  $T_{vjmax} = 175^\circ\text{C}$
- Qualified according to JEDEC for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: <http://www.infineon.com/igbt7/>

### Potential applications

- Servo drives
- General purpose drives (GPD)
- Industrial UPS
- Industrial SMPS
- Solar optimizer
- Solar string inverter

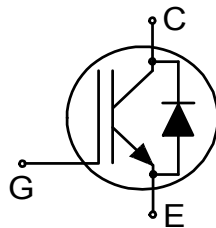
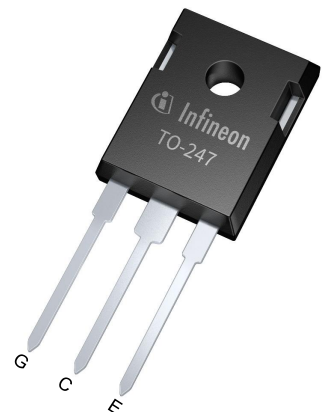
### Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

### Description

Package pin definition:

- Pin C & backside - Collector
- Pin E - Emitter
- Pin G - Gate



Type	Package	Marking
IKW75N65ET7	PG-TO247-3	K75EET7

## Table of contents

	<b>Description</b> .....	1
	<b>Features</b> .....	1
	<b>Potential applications</b> .....	1
	<b>Product validation</b> .....	1
	<b>Table of contents</b> .....	2
<b>1</b>	<b>Package</b> .....	3
<b>2</b>	<b>IGBT</b> .....	3
<b>3</b>	<b>Diode</b> .....	6
<b>4</b>	<b>Characteristics diagrams</b> .....	9
<b>5</b>	<b>Package outlines</b> .....	16
<b>6</b>	<b>Testing conditions</b> .....	17
	<b>Revision history</b> .....	18
	<b>Disclaimer</b> .....	19

## 1 Package

**Table 1** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Internal emitter inductance measured 5 mm (0.197 in.) from case	$L_E$			13		nH
Storage temperature	$T_{stg}$		-55		150	°C
Soldering temperature	$T_{sold}$	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Mounting torque	$M$	M3 screw, Maximum of mounting processes: 3			0.6	Nm
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
IGBT thermal resistance, junction-case	$R_{th(j-c)}$				0.45	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$				0.6	K/W

## 2 IGBT

**Table 2** Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
Collector-emitter voltage	$V_{CE}$	$T_{vj} \geq 25\text{ °C}$	650	V	
DC collector current, limited by $T_{vjmax}$	$I_C$	limited by bondwire	$T_c = 25\text{ °C}$	80	A
			$T_c = 100\text{ °C}$	78.5	
Pulsed collector current, $t_p$ limited by $T_{vjmax}$ <sup>1)</sup>	$I_{Cpulse}$		225	A	
Turn-off safe operating area <sup>2)</sup>		$V_{CE} \leq 650\text{ V}$ , $t_p = 1\text{ }\mu\text{s}$ , $T_{vj} \leq 175\text{ °C}$	225	A	
Gate-emitter voltage	$V_{GE}$		$\pm 20$	V	
Transient gate-emitter voltage	$V_{GE}$	$t_p \leq 10\text{ }\mu\text{s}$ , $D < 0.01$	$\pm 30$	V	
Short-circuit withstand time	$t_{SC}$	$V_{GE} = 15\text{ V}$ , Allowed number of short circuits < 1000, Time between short circuits $\geq 1.0\text{ s}$	$V_{CC} \leq 330\text{ V}$ , $T_{vj} = 100\text{ °C}$	5	$\mu\text{s}$
			$V_{CC} \leq 400\text{ V}$ , $T_{vj} = 150\text{ °C}$	3	
Power dissipation	$P_{tot}$		$T_c = 25\text{ °C}$	333	W
			$T_c = 100\text{ °C}$	167	

1) Defined by design. Not subject to production test.

2) Clamped inductive load current test for each device,  $I_C = 225\text{ A}$ ,  $V_{CC} = 400\text{ V}$ ,  $T_c = 25\text{ °C}$ ,  $V_{GE} = 20\text{ V}$ ,  $L = 80\text{ }\mu\text{H}$ ,  $R_G = 10\text{ }\Omega$

**Table 3** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CEsat}$	$I_C = 75\text{ A}, V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$	1.35	1.65	V
			$T_{vj} = 125\text{ °C}$	1.5		
			$T_{vj} = 175\text{ °C}$	1.6		
Gate-emitter threshold voltage	$V_{GETh}$	$I_C = 0.75\text{ mA}, V_{CE} = V_{GE}$	4.3	5	5.7	V
Zero gate-voltage collector current	$I_{CES}$	$V_{CE} = 650\text{ V}, V_{GE} = 0\text{ V}$	$T_{vj} = 25\text{ °C}$		40	$\mu\text{A}$
			$T_{vj} = 175\text{ °C}$		1200	
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}$			100	nA
Transconductance	$g_{fs}$	$I_C = 75\text{ A}, V_{CE} = 20\text{ V}$		40		S
Short-circuit collector current	$I_{SC}$	$V_{CC} \leq 400\text{ V}, V_{GE} = 15\text{ V}, t_{SC} \leq 3\text{ }\mu\text{s}$ , Allowed number of short circuits < 1000, Time between short circuits $\geq 1.0\text{ s}$ , $T_{vj} = 150\text{ °C}$		350		A
Input capacitance	$C_{ies}$	$V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1000\text{ kHz}$		4460		pF
Output capacitance	$C_{oes}$	$V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1000\text{ kHz}$		135		pF
Reverse transfer capacitance	$C_{res}$	$V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1000\text{ kHz}$		46		pF
Gate charge	$Q_G$	$I_C = 75\text{ A}, V_{GE} = 15\text{ V}, V_{CC} = 520\text{ V}$		435		nC
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 400\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 4.7\text{ }\Omega, R_{G(off)} = 4.7\text{ }\Omega, L_\sigma = 32\text{ nH}, C_\sigma = 30\text{ pF}$	$T_{vj} = 25\text{ °C}, I_C = 75\text{ A}$	28		ns
			$T_{vj} = 25\text{ °C}, I_C = 37.5\text{ A}$	26		
			$T_{vj} = 175\text{ °C}, I_C = 75\text{ A}$	31		
			$T_{vj} = 175\text{ °C}, I_C = 37.5\text{ A}$	28		
Rise time (inductive load)	$t_r$	$V_{CC} = 400\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 4.7\text{ }\Omega, R_{G(off)} = 4.7\text{ }\Omega, L_\sigma = 32\text{ nH}, C_\sigma = 30\text{ pF}$	$T_{vj} = 25\text{ °C}, I_C = 75\text{ A}$	25		ns
			$T_{vj} = 25\text{ °C}, I_C = 37.5\text{ A}$	13		
			$T_{vj} = 175\text{ °C}, I_C = 75\text{ A}$	30		
			$T_{vj} = 175\text{ °C}, I_C = 37.5\text{ A}$	18		

(table continues...)

**Table 3 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 400\text{ V}, V_{GE} = 0/15\text{ V},$ $R_{G(on)} = 4.7\ \Omega,$ $R_{G(off)} = 4.7\ \Omega, L_{\sigma} = 32\text{ nH},$ $C_{\sigma} = 30\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 75\text{ A}$		310	ns
			$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 37.5\text{ A}$		330	
			$T_{vj} = 175\text{ }^{\circ}\text{C},$ $I_C = 75\text{ A}$		365	
			$T_{vj} = 175\text{ }^{\circ}\text{C},$ $I_C = 37.5\text{ A}$		415	
Fall time (inductive load)	$t_f$	$V_{CC} = 400\text{ V}, V_{GE} = 0/15\text{ V},$ $R_{G(on)} = 4.7\ \Omega,$ $R_{G(off)} = 4.7\ \Omega, L_{\sigma} = 32\text{ nH},$ $C_{\sigma} = 30\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 75\text{ A}$		15	ns
			$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 37.5\text{ A}$		11	
			$T_{vj} = 175\text{ }^{\circ}\text{C},$ $I_C = 75\text{ A}$		25	
			$T_{vj} = 175\text{ }^{\circ}\text{C},$ $I_C = 37.5\text{ A}$		20	
Turn-on energy	$E_{on}$	$V_{CC} = 400\text{ V}, V_{GE} = 0/15\text{ V},$ $R_{G(on)} = 4.7\ \Omega,$ $R_{G(off)} = 4.7\ \Omega, L_{\sigma} = 32\text{ nH},$ $C_{\sigma} = 30\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 75\text{ A}$		2.17	mJ
			$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 37.5\text{ A}$		0.79	
			$T_{vj} = 175\text{ }^{\circ}\text{C},$ $I_C = 75\text{ A}$		3.45	
			$T_{vj} = 175\text{ }^{\circ}\text{C},$ $I_C = 37.5\text{ A}$		1.52	
Turn-off energy	$E_{off}$	$V_{CC} = 400\text{ V}, V_{GE} = 0/15\text{ V},$ $R_{G(on)} = 4.7\ \Omega,$ $R_{G(off)} = 4.7\ \Omega, L_{\sigma} = 32\text{ nH},$ $C_{\sigma} = 30\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 75\text{ A}$		1.23	mJ
			$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 37.5\text{ A}$		0.56	
			$T_{vj} = 175\text{ }^{\circ}\text{C},$ $I_C = 75\text{ A}$		2.05	
			$T_{vj} = 175\text{ }^{\circ}\text{C},$ $I_C = 37.5\text{ A}$		1.11	

(table continues...)

**Table 3 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Total switching energy	$E_{ts}$	$V_{CC} = 400\text{ V}, V_{GE} = 0/15\text{ V},$ $R_{G(on)} = 4.7\ \Omega,$ $R_{G(off)} = 4.7\ \Omega, L_{\sigma} = 32\text{ nH},$ $C_{\sigma} = 30\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 75\text{ A}$		3.4		mJ
			$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 37.5\text{ A}$		1.35		
			$T_{vj} = 175\text{ }^{\circ}\text{C},$ $I_C = 75\text{ A}$		5.5		
			$T_{vj} = 175\text{ }^{\circ}\text{C},$ $I_C = 37.5\text{ A}$		2.63		
Operating junction temperature	$T_{vj}$		-40		175	$^{\circ}\text{C}$	

### 3 Diode

**Table 4 Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj} \geq 25\text{ }^{\circ}\text{C}$	650	V	
Diode forward current, limited by $T_{vjmax}$	$I_F$	limited by bondwire	$T_C = 25\text{ }^{\circ}\text{C}$	80	A
			$T_C = 100\text{ }^{\circ}\text{C}$	74	
Diode pulsed current, $t_p$ limited by $T_{vjmax}$ <sup>1)</sup>	$I_{Fpulse}$		225	A	

1) Defined by design. Not subject to production test.

**Table 5 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Diode forward voltage	$V_F$	$I_F = 75\text{ A}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$		1.65	2	V
			$T_{vj} = 125\text{ }^{\circ}\text{C}$		1.6		
			$T_{vj} = 175\text{ }^{\circ}\text{C}$		1.55		

(table continues...)

**Table 5 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Diode reverse recovery time	$t_{rr}$	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ °C}$ , $I_F = 75\text{ A}$ , $-di_F/dt = 1650\text{ A}/\mu\text{s}$		100		ns
			$T_{vj} = 25\text{ °C}$ , $I_F = 37.5\text{ A}$ , $-di_F/dt = 2725\text{ A}/\mu\text{s}$		70		
			$T_{vj} = 175\text{ °C}$ , $I_F = 75\text{ A}$ , $-di_F/dt = 1650\text{ A}/\mu\text{s}$		155		
			$T_{vj} = 175\text{ °C}$ , $I_F = 37.5\text{ A}$ , $-di_F/dt = 2260\text{ A}/\mu\text{s}$		125		
Diode reverse recovery charge	$Q_{rr}$	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ °C}$ , $I_F = 75\text{ A}$ , $-di_F/dt = 1650\text{ A}/\mu\text{s}$		1.5		$\mu\text{C}$
			$T_{vj} = 25\text{ °C}$ , $I_F = 37.5\text{ A}$ , $-di_F/dt = 2725\text{ A}/\mu\text{s}$		1.15		
			$T_{vj} = 175\text{ °C}$ , $I_F = 75\text{ A}$ , $-di_F/dt = 1650\text{ A}/\mu\text{s}$		4.4		
			$T_{vj} = 175\text{ °C}$ , $I_F = 37.5\text{ A}$ , $-di_F/dt = 2260\text{ A}/\mu\text{s}$		3.36		
Diode peak reverse recovery current	$I_{rrm}$	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ °C}$ , $I_F = 75\text{ A}$ , $-di_F/dt = 1650\text{ A}/\mu\text{s}$		22		A
			$T_{vj} = 25\text{ °C}$ , $I_F = 37.5\text{ A}$ , $-di_F/dt = 2725\text{ A}/\mu\text{s}$		34		
			$T_{vj} = 175\text{ °C}$ , $I_F = 75\text{ A}$ , $-di_F/dt = 1650\text{ A}/\mu\text{s}$		41		
			$T_{vj} = 175\text{ °C}$ , $I_F = 37.5\text{ A}$ , $-di_F/dt = 2260\text{ A}/\mu\text{s}$		43		

**(table continues...)**

**Table 5 (continued) Characteristic values**

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode peak rate of fall of reverse recovery current	$di_{rr}/dt$	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ °C},$ $I_F = 75\text{ A},$ $-di_F/dt = 1650\text{ A}/\mu\text{s}$		480		A/ $\mu\text{s}$
			$T_{vj} = 25\text{ °C},$ $I_F = 37.5\text{ A},$ $-di_F/dt = 2725\text{ A}/\mu\text{s}$		600		
			$T_{vj} = 175\text{ °C},$ $I_F = 75\text{ A},$ $-di_F/dt = 1650\text{ A}/\mu\text{s}$		590		
			$T_{vj} = 175\text{ °C},$ $I_F = 37.5\text{ A},$ $-di_F/dt = 2260\text{ A}/\mu\text{s}$		500		
Operating junction temperature	$T_{vj}$			-40		175	°C

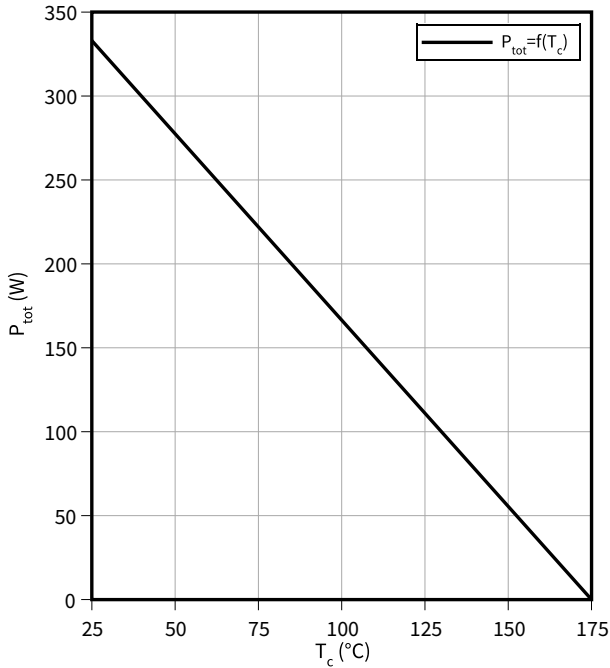
**Note:** *Maximum rated values: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.*  
*Electrical Characteristic, at  $T_{vj} = 25\text{ °C}$ , unless otherwise specified.*  
*Dynamic test circuit,  $L_\sigma, C_\sigma$  from Fig. E. Energy losses include “tail” and diode reverse recovery.*



## 4 Characteristics diagrams

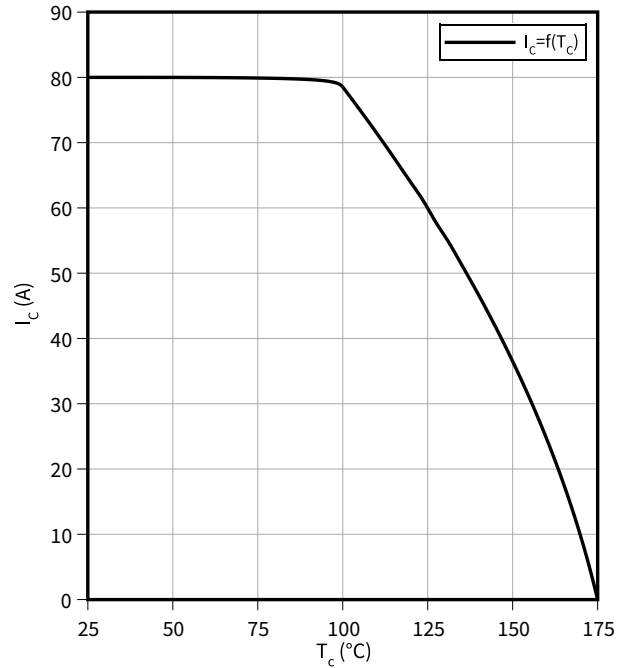
### Power dissipation as a function of case temperature

$P_{tot} = f(T_c)$   
 $T_{vj} \leq 175\text{ }^\circ\text{C}$



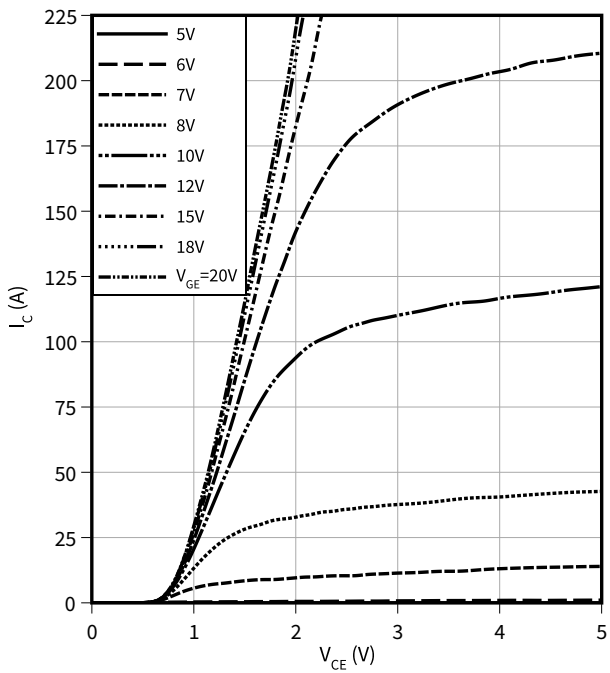
### Collector current as a function of case temperature

$I_C = f(T_c)$   
 $T_{vj} \leq 175\text{ }^\circ\text{C}, V_{GE} \geq 15\text{ V}$



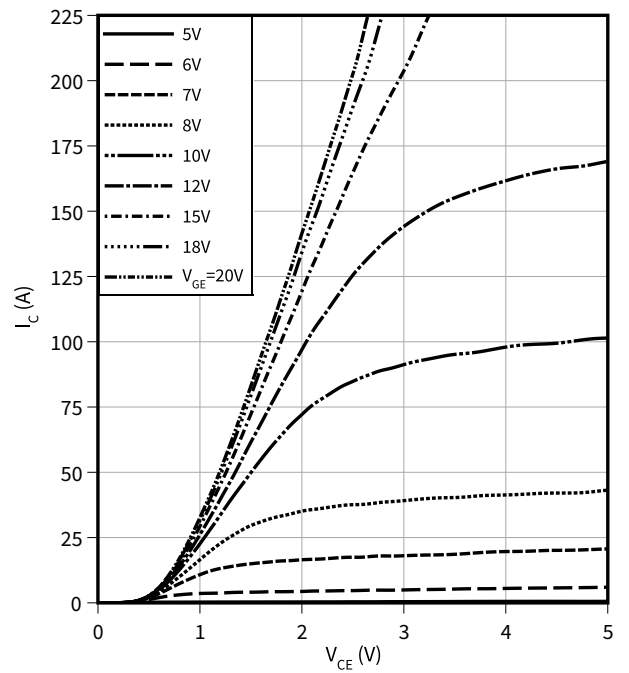
### Typical output characteristic

$I_C = f(V_{CE})$   
 $T_{vj} = 25\text{ }^\circ\text{C}$



### Typical output characteristic

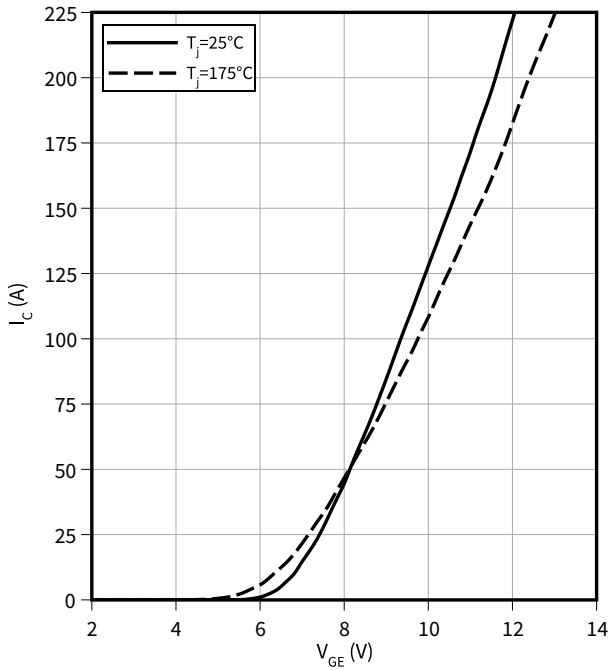
$I_C = f(V_{CE})$   
 $T_{vj} = 175\text{ }^\circ\text{C}$



4 Characteristics diagrams

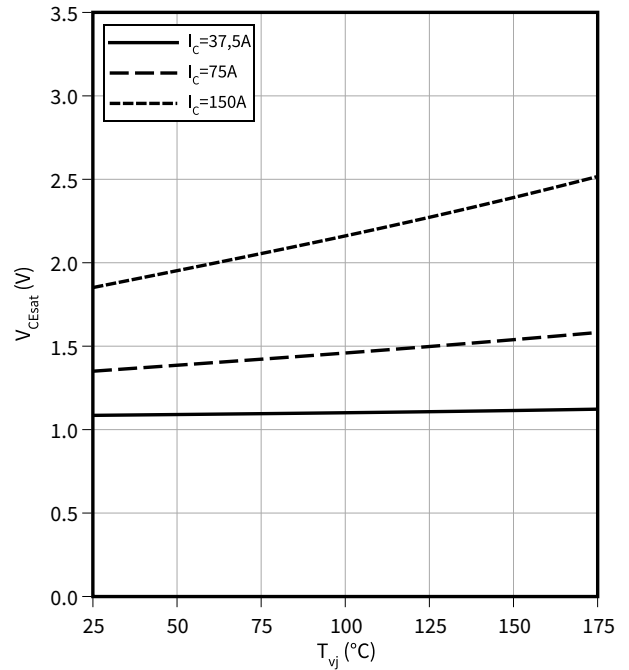
**Typical transfer characteristic**

$I_C = f(V_{GE})$   
 $V_{CE} = 20 \text{ V}$



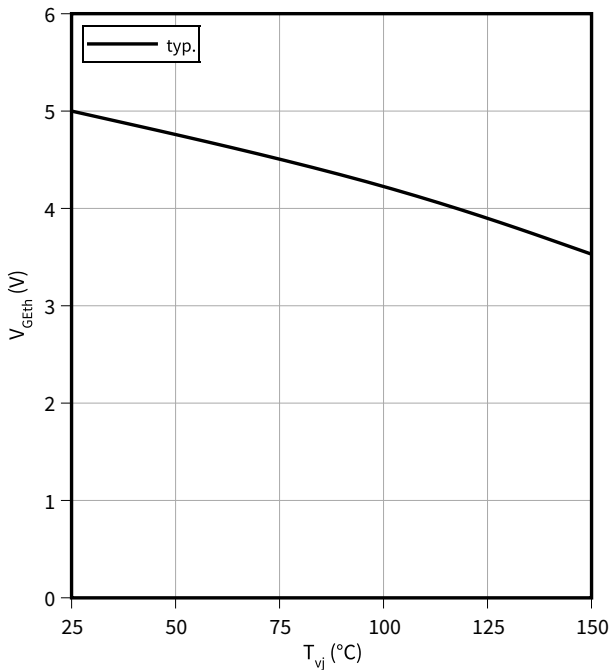
**Typical collector-emitter saturation voltage as a function of junction temperature**

$V_{CEsat} = f(T_{vj})$   
 $V_{GE} = 15 \text{ V}$



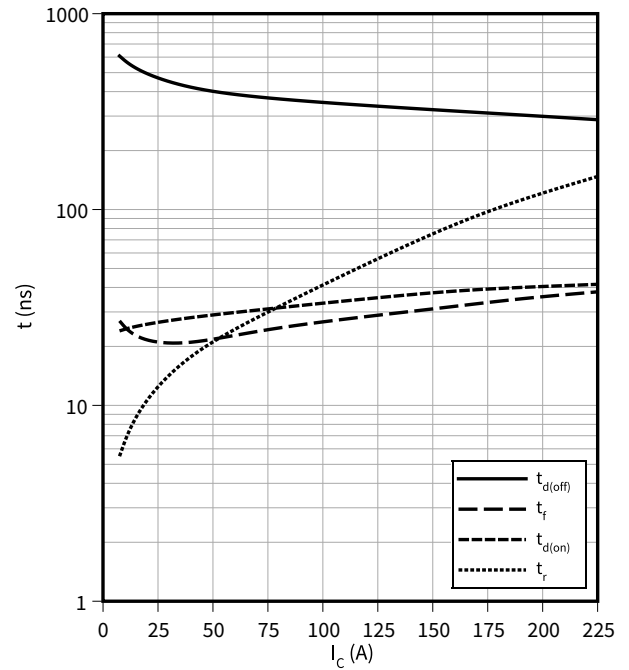
**Gate-emitter threshold voltage as a function of junction temperature**

$V_{GEth} = f(T_{vj})$   
 $I_C = 0.75 \text{ mA}$



**Typical switching times as a function of collector current**

$t = f(I_C)$   
 $V_{CC} = 400 \text{ V}, T_{vj} = 175^\circ\text{C}, V_{GE} = 0/15 \text{ V}, R_G = 4.7 \Omega$

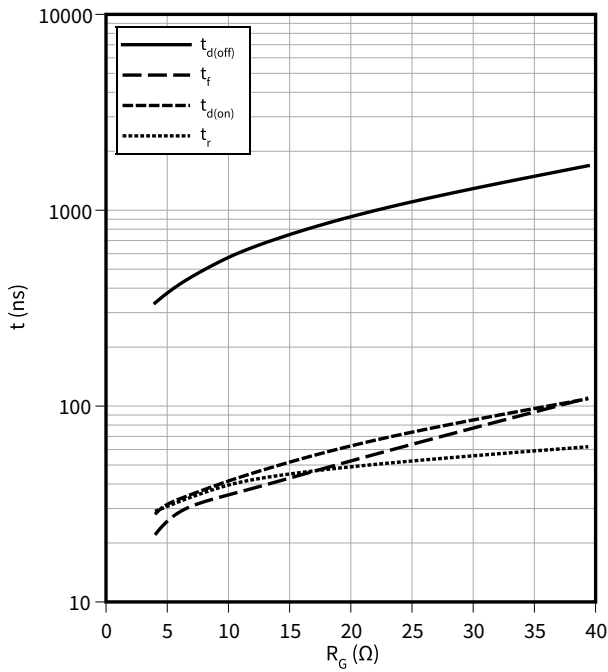


4 Characteristics diagrams

**Typical switching times as a function of gate resistor**

$t = f(R_G)$

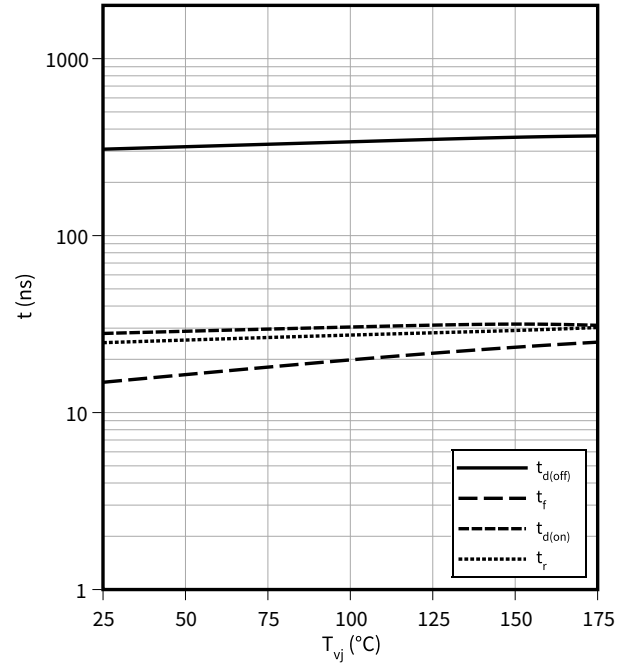
$I_C = 75 \text{ A}, V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ }^\circ\text{C}, V_{GE} = 0/15 \text{ V}$



**Typical switching times as a function of junction temperature**

$t = f(T_{vj})$

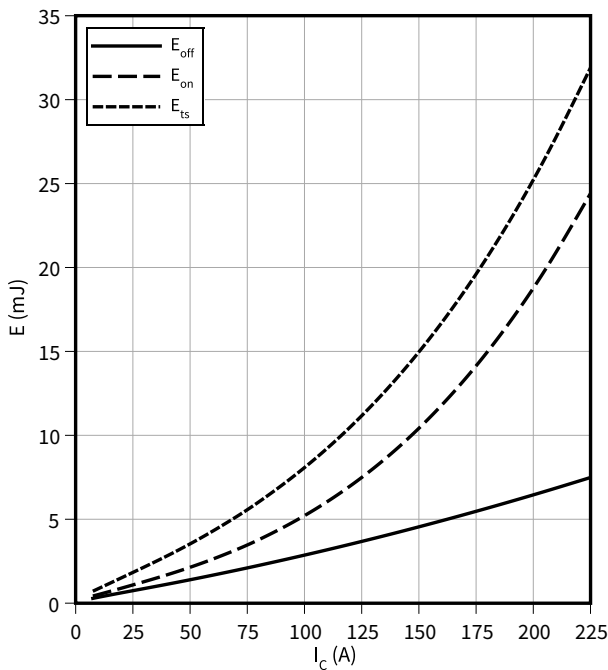
$I_C = 75 \text{ A}, V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 4.7 \text{ } \Omega$



**Typical switching energy losses as a function of collector current**

$E = f(I_C)$

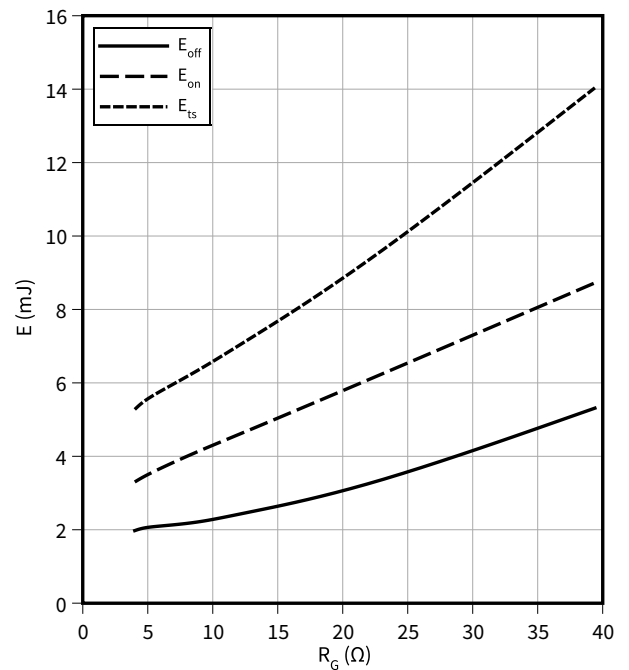
$V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ }^\circ\text{C}, V_{GE} = 0/15 \text{ V}, R_G = 4.7 \text{ } \Omega$



**Typical switching energy losses as a function of gate resistor**

$E = f(R_G)$

$I_C = 75 \text{ A}, V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ }^\circ\text{C}, V_{GE} = 0/15 \text{ V}$

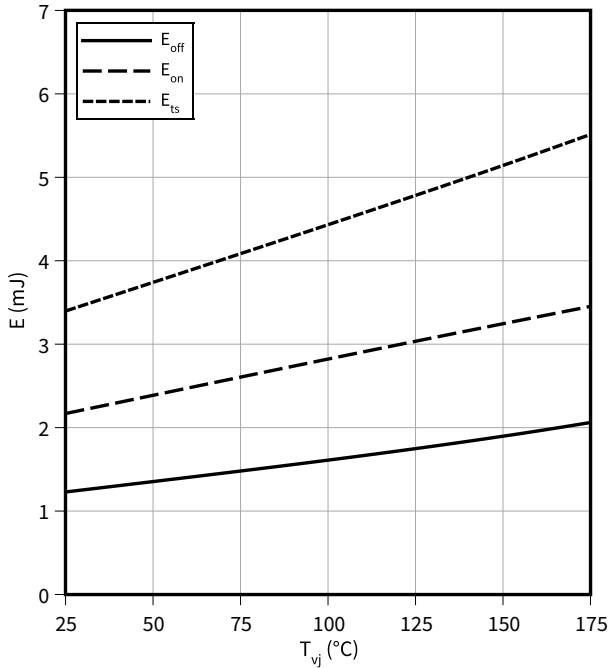


4 Characteristics diagrams

**Typical switching energy losses as a function of junction temperature**

$E = f(T_{vj})$

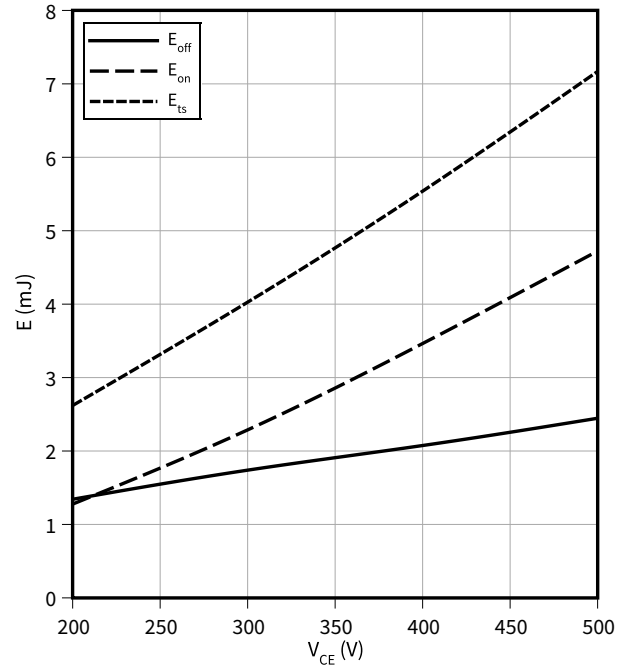
$I_C = 75 \text{ A}$ ,  $V_{CC} = 400 \text{ V}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 4.7 \Omega$



**Typical switching energy losses as a function of collector emitter voltage**

$E = f(V_{CE})$

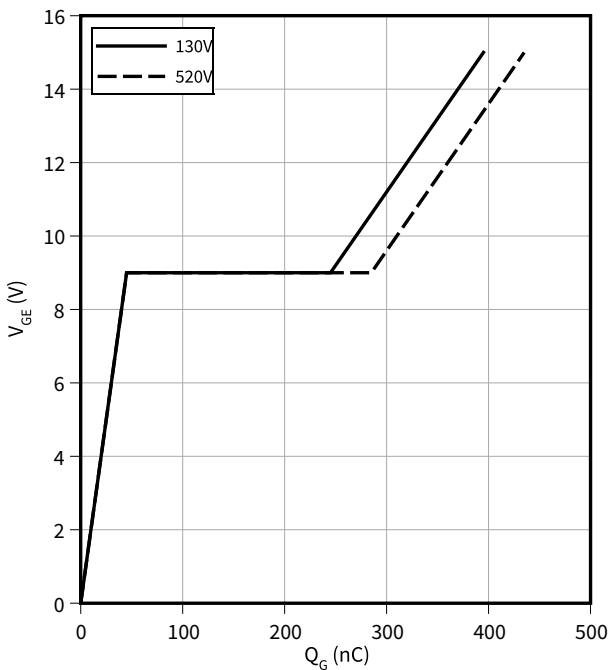
$I_C = 75 \text{ A}$ ,  $T_{vj} = 175 \text{ °C}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 4.7 \Omega$



**Typical gate charge**

$V_{GE} = f(Q_G)$

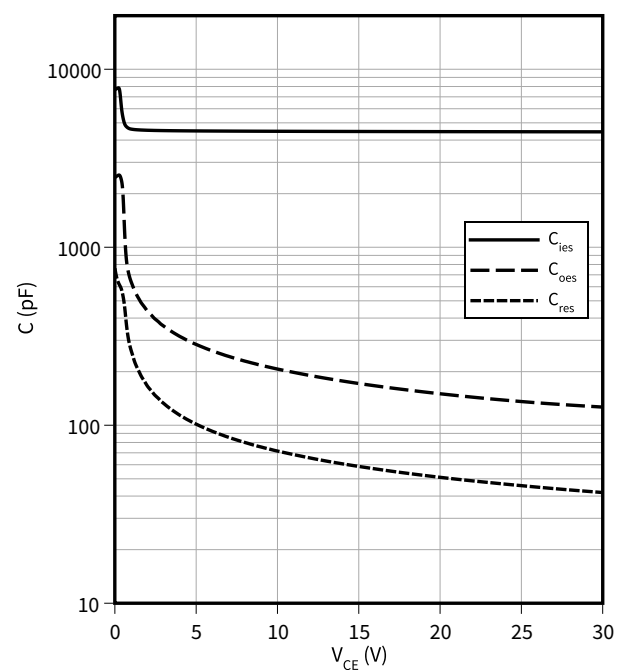
$I_C = 75 \text{ A}$



**Typical capacitance as a function of collector-emitter voltage**

$C = f(V_{CE})$

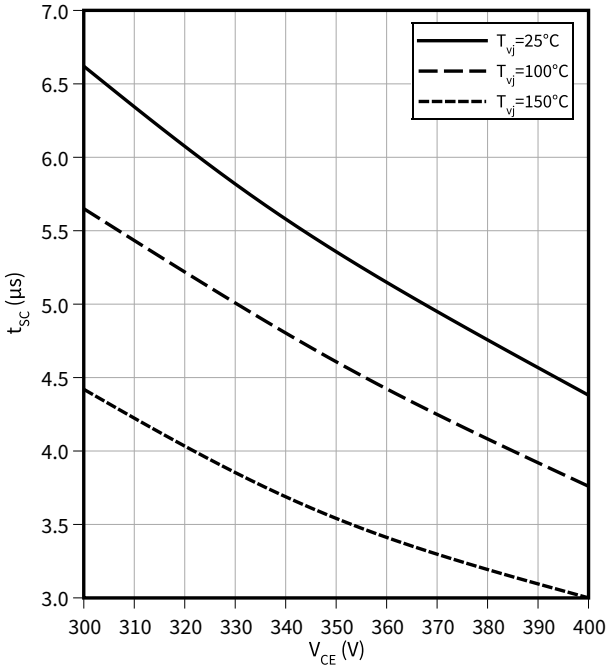
$f = 1000 \text{ kHz}$ ,  $V_{GE} = 0 \text{ V}$



4 Characteristics diagrams

**Typical short circuit safe operating range as a function of collector-emitter voltage**

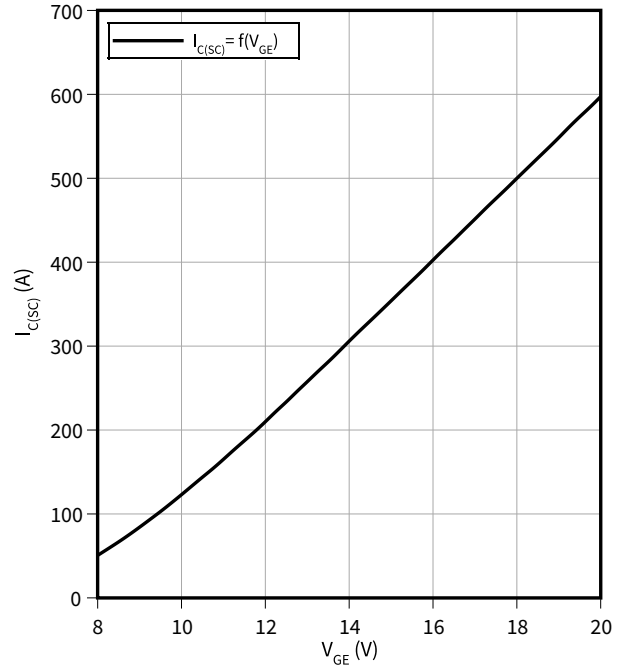
$$t_{SC} = f(V_{CE})$$



**Typical short circuit collector current as a function of gate-emitter voltage**

$$I_{C(SC)} = f(V_{GE})$$

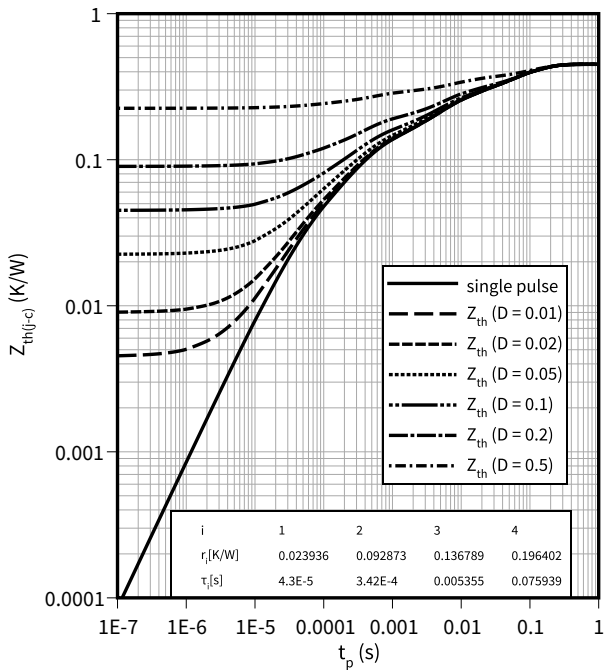
$T_{vj} = 150\text{ }^{\circ}\text{C}, V_{CE} \leq 400\text{ V}$



**IGBT transient thermal impedance as a function of pulse width**

$$Z_{th(j-c)} = f(t_p)$$

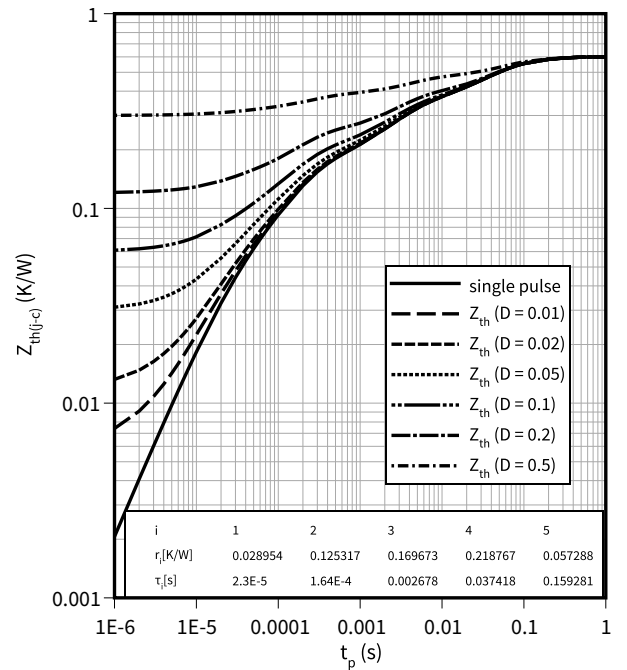
$$D = t_p/T$$



**Diode transient thermal impedance as a function of pulse width**

$$Z_{th(j-c)} = f(t_p)$$

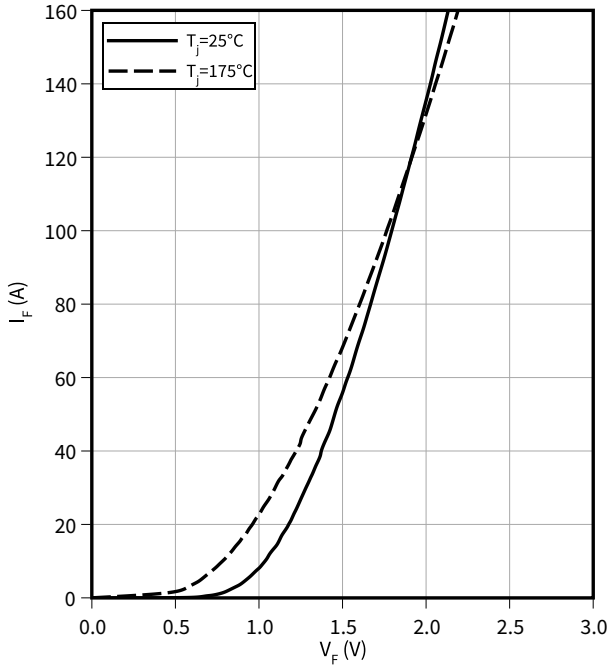
$$D = t_p/T$$



4 Characteristics diagrams

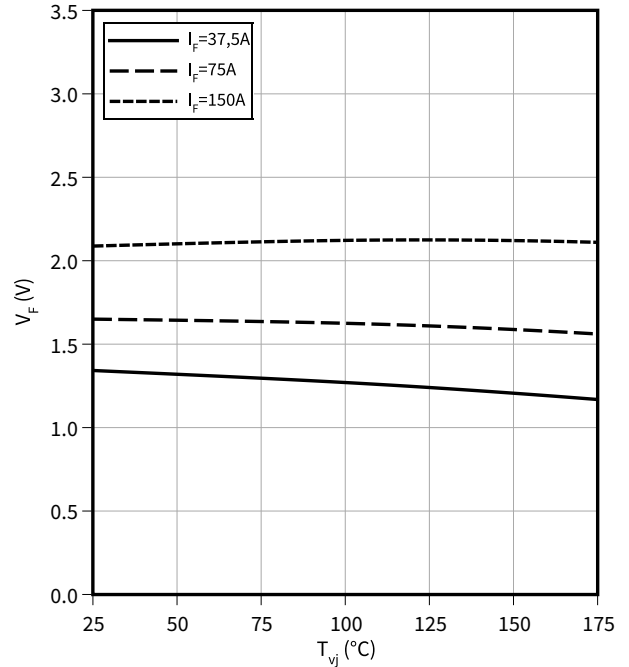
**Typical diode forward current as a function of forward voltage**

$I_F = f(V_F)$



**Typical diode forward voltage as a function of junction temperature**

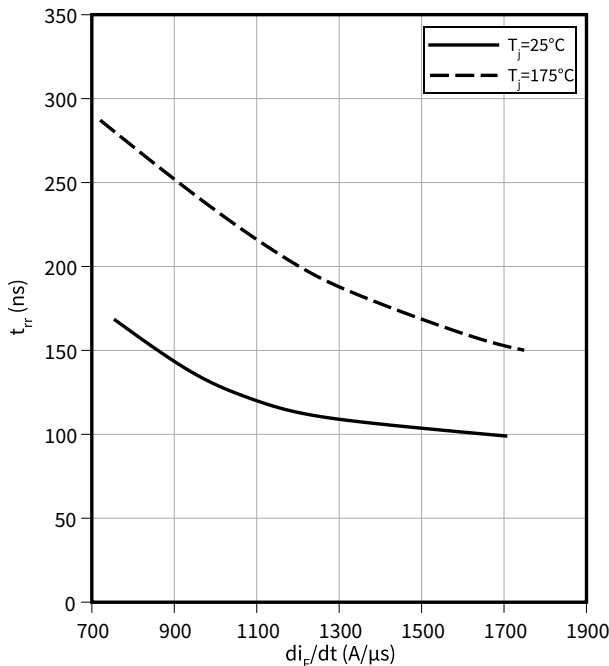
$V_F = f(T_{vj})$



**Typical reverse recovery time as a function of diode current slope**

$t_{rr} = f(di_F/dt)$

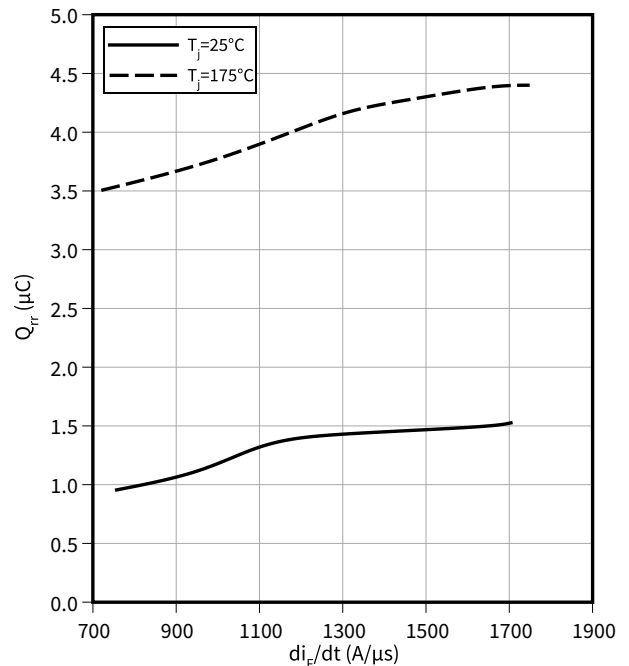
$V_R = 400\text{ V}, I_F = 75\text{ A}$



**Typical reverse recovery charge as a function of diode current slope**

$Q_{rr} = f(di_F/dt)$

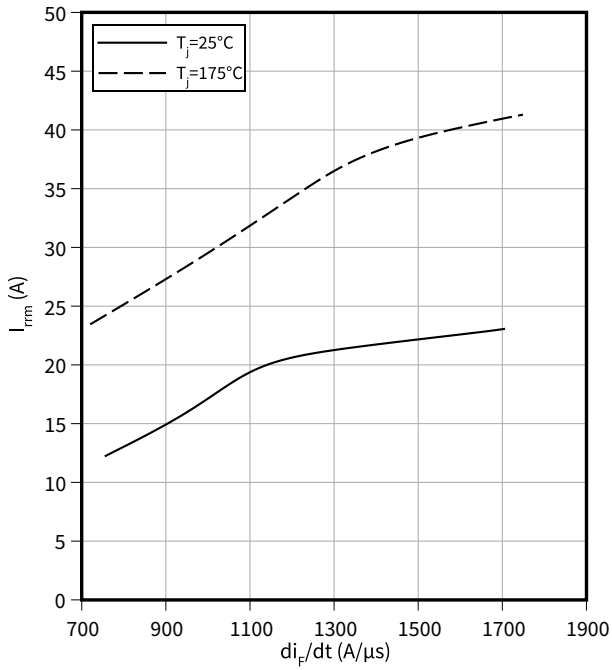
$V_R = 400\text{ V}, I_F = 75\text{ A}$



**Typical reverse recovery current as a function of diode current slope**

$$I_{rrm} = f(di_F/dt)$$

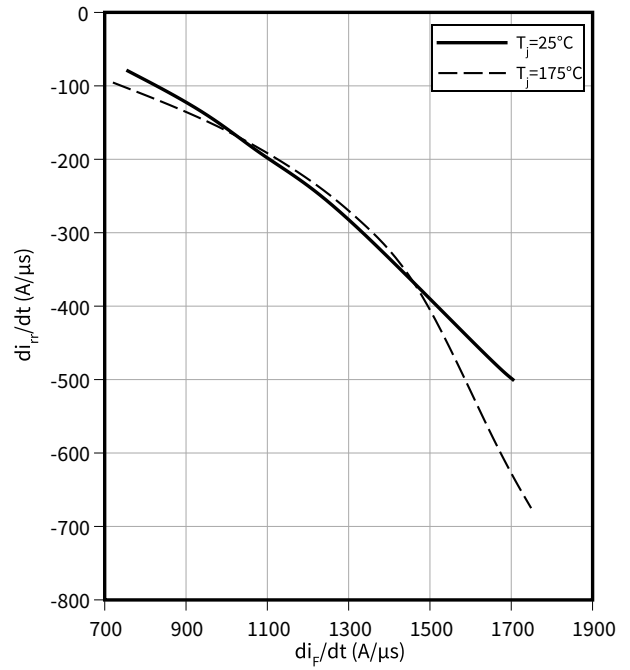
$V_R = 400\text{ V}$ ,  $I_F = 75\text{ A}$



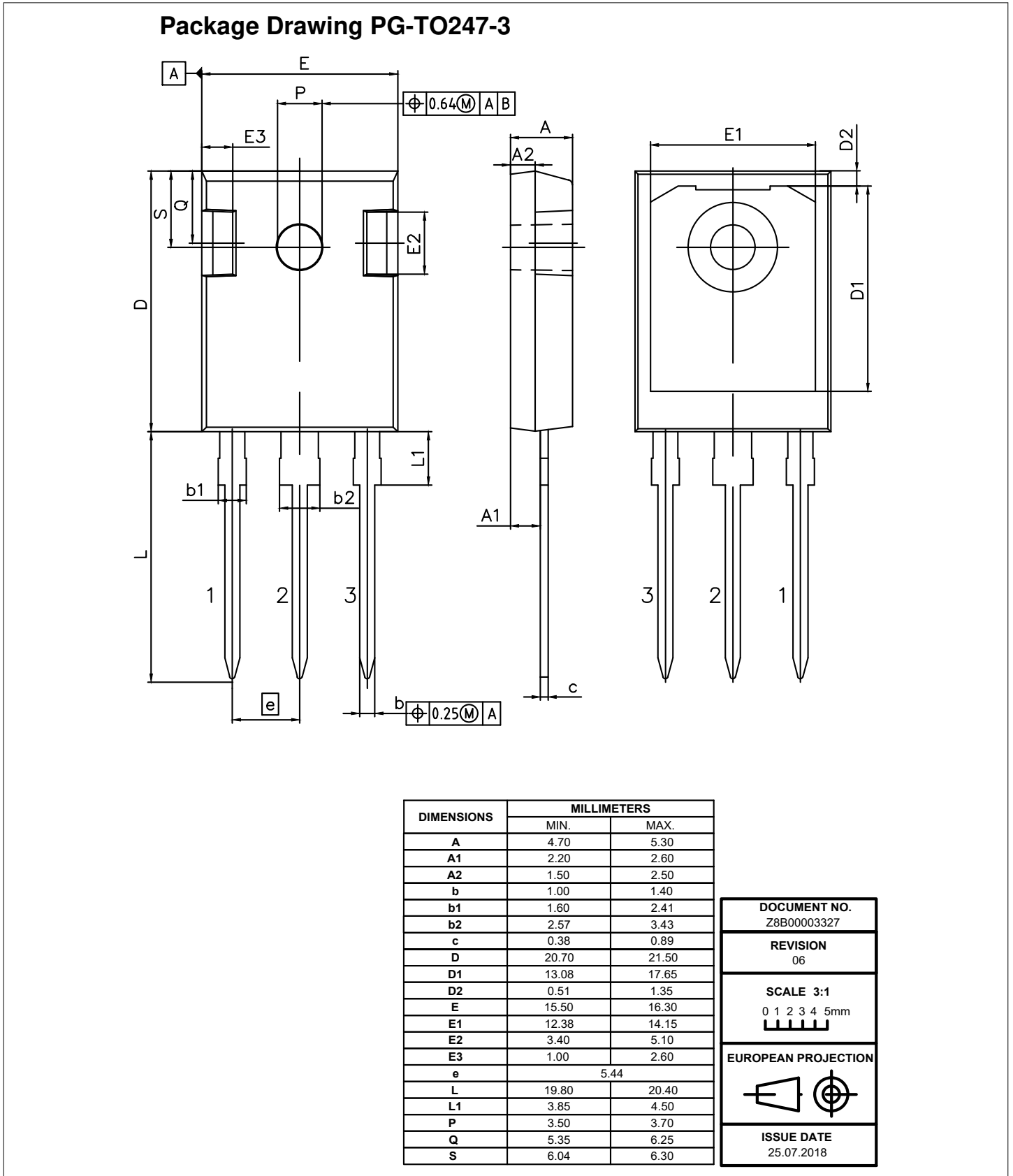
**Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**

$$di_{rr}/dt = f(di_F/dt)$$

$V_R = 400\text{ V}$ ,  $I_F = 75\text{ A}$



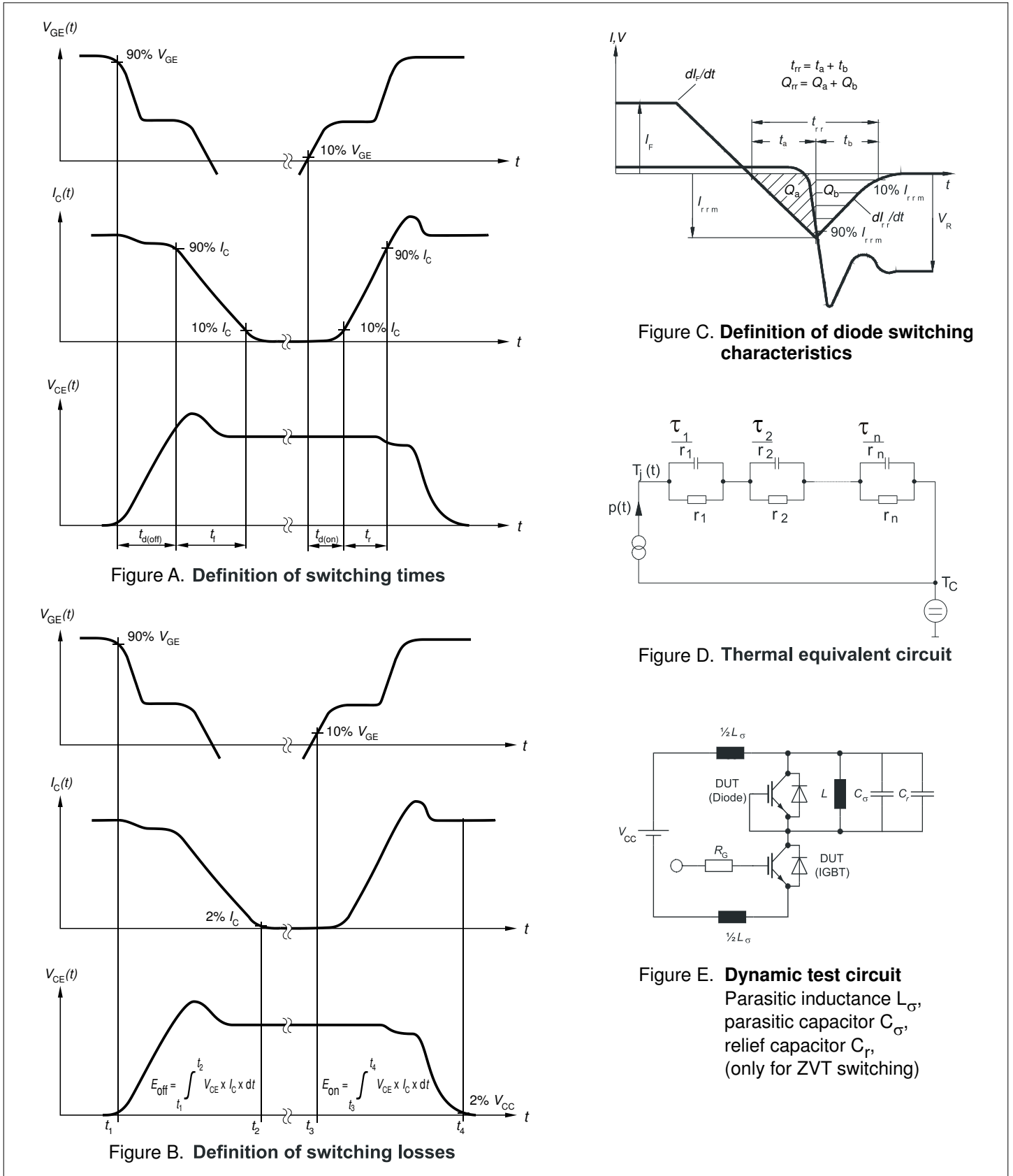
**5 Package outlines**



**Figure 1**



**6 Testing conditions**



**Figure 2**

## Revision history

Document revision	Date of release	Description of changes
V0.1	2019-10-25	Target Data Sheet
V1.1	2020-04-20	Preliminary data sheet
V2.1	2020-05-12	Final data sheet
n/a	2020-11-30	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
1.00	2021-06-29	Change of potential applications and new diagram added ( $t_{SC}$ as function of $V_{CE}$ )
1.10	2023-01-26	Feature list corrections Editorial changes

## Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

**Edition 2023-01-26**

**Published by**

**Infineon Technologies AG**

**81726 Munich, Germany**

**© 2023 Infineon Technologies AG**

**All Rights Reserved.**

**Do you have a question about any aspect of this document?**

**Email: [erratum@infineon.com](mailto:erratum@infineon.com)**

**Document reference**

**IFX-AAL330-005**

## Important notice

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Please note that this product is not qualified according to the AEC Q100 or AEC Q101 documents of the Automotive Electronics Council.

## Warnings

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.